

# CMOS 4-Bit Magnitude Comparator

## High Voltage Types (20-Volt Rating)

■ CD4585B is a 4-bit magnitude comparator designed for use in computer and logic applications that require the comparison of two 4-bit words. This logic circuit determines whether one 4-bit word (Binary or BCD) is "less than", "equal to", or "greater than" a second 4-bit word.

The CD4585B has eight comparing inputs (A3, B3, through A0, B0), three outputs (A < B, A = B, A > B) and three cascading inputs (A < B, A = B, A > B) that permit systems designers to expand the comparator function to 8, 12, 16.....4N bits. When a single CD4585B is used, the cascading inputs are connected as follows: (A < B) = low, (A = B) = high, (A > B) = high.

Cascading these units for comparison of more than 4 bits is accomplished as shown in Fig. 13.

The CD4585B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

### Features:

- Expansion to 8, 12, 16.....4N bits by cascading units
- Medium-speed operation:  
compares two 4-bit words  
in 180 ns (typ.) at 10 V
- 100% tested for quiescent current at 20 V
- Standardized symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of 1  $\mu$ A at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package temperature range)  
range) = 1 V at  $V_{DD} = 5$  V  
2 V at  $V_{DD} = 10$  V  
2.5 V at  $V_{DD} = 15$  V
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

### Applications:

- Servo motor controls
- Process controllers

# CD4585B Types

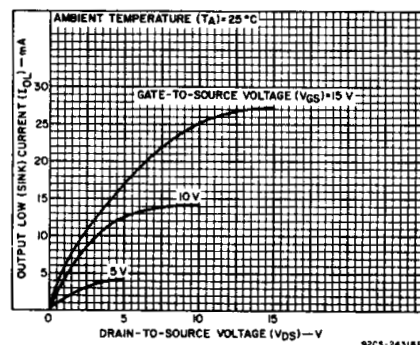
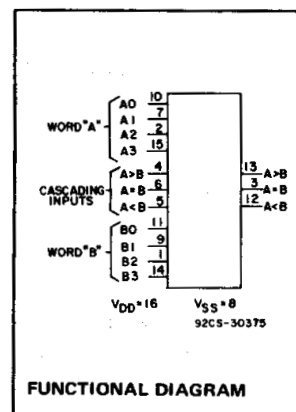


Fig. 1 - Typical output low (sink) current characteristics.

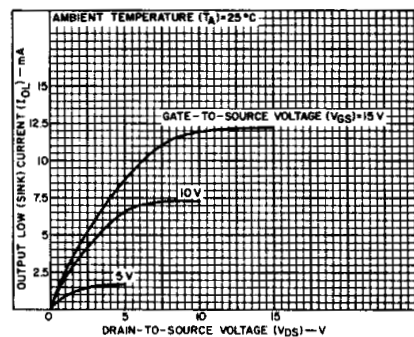


Fig. 2 - Minimum output low (sink) current characteristics.

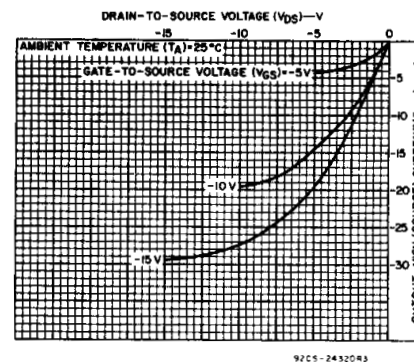


Fig. 3 - Typical output high (source) current characteristics.

### MAXIMUM RATINGS, Absolute-Maximum Values:

#### DC SUPPLY-VOLTAGE RANGE, ( $V_{DD}$ )

Voltages referenced to  $V_{SS}$  Terminal ..... -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS ..... -0.5V to  $V_{DD} + 0.5$  V

DC INPUT CURRENT, ANY ONE INPUT .....  $\pm 10$  mA

#### POWER DISSIPATION PER PACKAGE ( $P_D$ ):

For  $T_A = -55^\circ\text{C}$  to  $+100^\circ\text{C}$  ..... 500mW

For  $T_A = +100^\circ\text{C}$  to  $+125^\circ\text{C}$  ..... Derate Linearly at 12mW/ $^\circ\text{C}$  to 200mW

#### DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR  $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$  ..... 100mW

OPERATING-TEMPERATURE RANGE ( $T_A$ ) .....  $-55^\circ\text{C}$  to  $+125^\circ\text{C}$

STORAGE TEMPERATURE RANGE ( $T_{stg}$ ) .....  $-65^\circ\text{C}$  to  $+150^\circ\text{C}$

#### LEAD TEMPERATURE (DURING SOLDERING):

At distance 1/16  $\pm$  1/32 inch (1.59  $\pm$  0.79mm) from case for 10s max .....  $+265^\circ\text{C}$

### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

| CHARACTERISTIC  | LIMITS |      | UNITS |
|---|--------|------|-------|
|   | Min.   | Max. |       |
| Supply-Voltage Range (For $T_A = \text{Full Package-Temperature Range}$ ) | 3      | 18   | V     |

# CD4585B Types

TRUTH TABLE

| INPUTS    |         |         |         |           |       |       | OUTPUTS |       |       |
|-----------|---------|---------|---------|-----------|-------|-------|---------|-------|-------|
| COMPARING |         |         |         | CASCADING |       |       |         |       |       |
| A3, B3    | A2, B2  | A1, B1  | A0, B0  | A < B     | A = B | A > B | A < B   | A = B | A > B |
| A3 > B3   | X       | X       | X       | X         | X     | 1     | 0       | 0     | 1     |
| A3 = B3   | A2 > B2 | X       | X       | X         | X     | 1     | 0       | 0     | 1     |
| A3 = B3   | A2 = B2 | A1 > B1 | X       | X         | X     | 1     | 0       | 0     | 1     |
| A3 = B3   | A2 = B2 | A1 = B1 | A0 > B0 | X         | X     | 1     | 0       | 0     | 1     |
| A3 = B3   | A2 = B2 | A1 = B1 | A0 = B0 | 0         | 0     | 1     | 0       | 0     | 1     |
| A3 = B3   | A2 = B2 | A1 = B1 | A0 = B0 | 0         | 1     | X     | 0       | 1     | 0     |
| A3 = B3   | A2 = B2 | A1 = B1 | A0 = B0 | 1         | 0     | X     | 1       | 0     | 0     |
| A3 = B3   | A2 = B2 | A1 = B1 | A0 < B0 | X         | X     | X     | 1       | 0     | 0     |
| A3 = B3   | A2 = B2 | A1 < B1 | X       | X         | X     | X     | 1       | 0     | 0     |
| A3 = B3   | A2 < B2 | X       | X       | X         | X     | X     | 1       | 0     | 0     |
| A3 < B3   | X       | X       | X       | X         | X     | X     | 1       | 0     | 0     |

X = Don't Care

Logic 1 = High Level

Logic 0 = Low Level

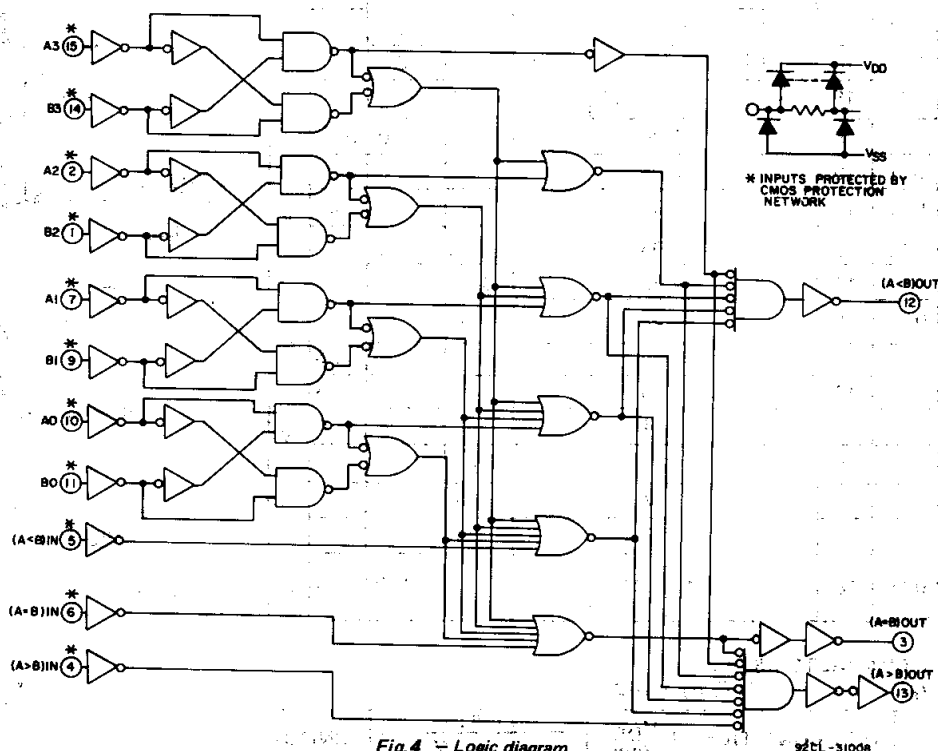


Fig. 4 - Logic diagram.

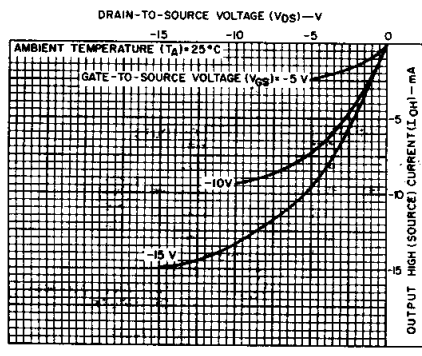


Fig. 5 - Minimum output high (source) current characteristics.

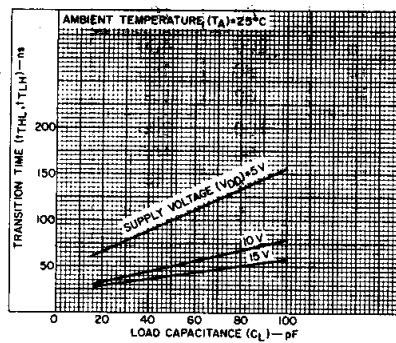


Fig. 6 - Typical transition time as a function of load capacitance.

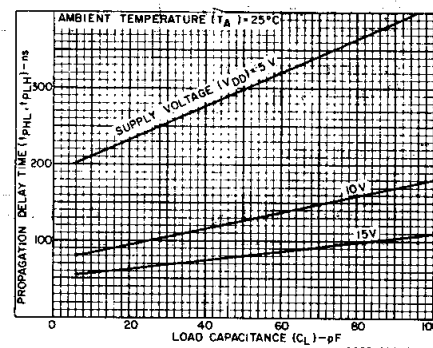


Fig. 7 - Typical propagation delay time ("comparing inputs" to outputs) as a function of load capacitance.

# CD4585B Types

## STATIC ELECTRICAL CHARACTERISTICS

| CHARACTERISTIC                                     | CONDITIONS            |                        |                        | LIMITS AT INDICATED TEMPERATURES (°C) |       |       |       |       |                   |      | UNITS |
|--|-----------------------|------------------------|------------------------|---------------------------------------|-------|-------|-------|-------|-------------------|------|-------|
|  | V <sub>O</sub><br>(V) | V <sub>IN</sub><br>(V) | V <sub>DD</sub><br>(V) | -55                                   | -40   | +85   | +125  | +25   |                   |      |       |
|  |                       |                        |                        |                                       |       |       |       | Min.  | Typ.              | Max. |       |
| Quiescent Device Current, I <sub>DD</sub> Max.     | —                     | 0,5                    | 5                      | 5                                     | 5     | 150   | 150   | —     | 0.04              | 5    | μA    |
|  | —                     | 0,10                   | 10                     | 10                                    | 10    | 300   | 300   | —     | 0.04              | 10   |       |
|  | —                     | 0,15                   | 15                     | 20                                    | 20    | 600   | 600   | —     | 0.04              | 20   |       |
|  | —                     | 0,20                   | 20                     | 100                                   | 100   | 3000  | 3000  | —     | 0.08              | 100  |       |
| Output Low (Sink) Current I <sub>OL</sub> Min.     | 0.4                   | 0,5                    | 5                      | 0.64                                  | 0.61  | 0.42  | 0.36  | 0.51  | 1                 | —    | mA    |
|  | 0.5                   | 0,10                   | 10                     | 1.6                                   | 1.5   | 1.1   | 0.9   | 1.3   | 2.6               | —    |       |
|  | 1.5                   | 0,15                   | 15                     | 4.2                                   | 4     | 2.8   | 2.4   | 3.4   | 6.8               | —    |       |
| Output High (Source) Current, I <sub>OH</sub> Min. | 4.6                   | 0,5                    | 5                      | -0.64                                 | -0.61 | -0.42 | -0.36 | -0.51 | -1                | —    | mA    |
|  | 2.5                   | 0,5                    | 5                      | -2                                    | -1.8  | -1.3  | -1.15 | -1.6  | -3.2              | —    |       |
|  | 9.5                   | 0,10                   | 10                     | -1.6                                  | -1.5  | -1.1  | -0.9  | -1.3  | -2.6              | —    |       |
|  | 13.5                  | 0,15                   | 15                     | -4.2                                  | -4    | -2.8  | -2.4  | -3.4  | -6.8              | —    |       |
| Output Voltage: Low-Level, V <sub>OL</sub> Max.    | —                     | 0,5                    | 5                      | 0.05                                  |       |       |       | —     | 0                 | 0.05 | V     |
|  | —                     | 0,10                   | 10                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
|  | —                     | 0,15                   | 15                     | 0.05                                  |       |       |       | —     | 0                 | 0.05 |       |
| Output Voltage: High-Level, V <sub>OH</sub> Min.   | —                     | 0,5                    | 5                      | 4.95                                  |       |       |       | 4.95  | 5                 | —    | V     |
|  | —                     | 0,10                   | 10                     | 9.95                                  |       |       |       | 9.95  | 10                | —    |       |
|  | —                     | 0,15                   | 15                     | 14.95                                 |       |       |       | 14.95 | 15                | —    |       |
| Input Low Voltage V <sub>IL</sub> Max.             | 0.5,4.5               | —                      | 5                      | 1.5                                   |       |       |       | —     | —                 | 1.5  | V     |
|  | 1,9                   | —                      | 10                     | 3                                     |       |       |       | —     | —                 | 3    |       |
|  | 1.5,13.5              | —                      | 15                     | 4                                     |       |       |       | —     | —                 | 4    |       |
| Input High Voltage, V <sub>IH</sub> Min.           | 0.5,4.5               | —                      | 5                      | 3.5                                   |       |       |       | 3.5   | —                 | —    | V     |
|  | 1,9                   | —                      | 10                     | 7                                     |       |       |       | 7     | —                 | —    |       |
|  | 1.5,13.5              | —                      | 15                     | 11                                    |       |       |       | 11    | —                 | —    |       |
| Input Current I <sub>IN</sub> Max.                 | —                     | 0,18                   | 18                     | ±0.1                                  | ±0.1  | ±1    | ±1    | —     | ±10 <sup>-5</sup> | ±0.1 | μA    |

## DYNAMIC ELECTRICAL CHARACTERISTICS

At T<sub>A</sub> = 25°C; Input t<sub>r</sub>, t<sub>f</sub> = 20 ns, C<sub>L</sub> = 50 pF, R<sub>L</sub> = 200 kΩ

| CHARACTERISTIC   | TEST CONDITIONS | V <sub>DD</sub><br>Volts | LIMITS |      | UNITS |
|--|-----------------|--------------------------|--------|------|-------|
|  |                 |                          | Typ.   | Max. |       |
| Propagation Delay Time: Comparing Inputs to Outputs, t <sub>PHL</sub> , t <sub>PLH</sub> |                 | 5                        | 300    | 600  | ns    |
|  |                 | 10                       | 125    | 250  |       |
|  |                 | 15                       | 80     | 160  |       |
| Cascading Inputs to Outputs, t <sub>PHL</sub> , t <sub>PLH</sub>                         |                 | 5                        | 200    | 400  | ns    |
|  |                 | 10                       | 80     | 160  |       |
|  |                 | 15                       | 60     | 120  |       |
| Transition Time, t <sub>THL</sub> , t <sub>TLH</sub>                                     |                 | 5                        | 100    | 200  | ns    |
|  |                 | 10                       | 50     | 100  |       |
|  |                 | 15                       | 40     | 80   |       |
| Input Capacitance, C <sub>IN</sub>   | Any Input       |                          | 5      | 7.5  | pF    |

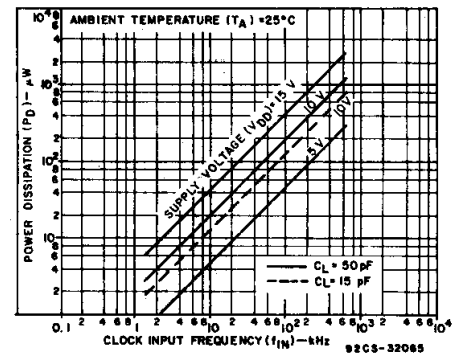


Fig. 8 — Typical dynamic power dissipation as a function of clock input frequency (see Fig. 9—dynamic power dissipation test circuit).

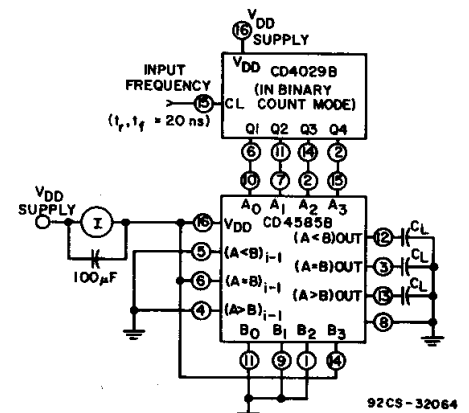


Fig. 9 — Dynamic power dissipation test circuit.

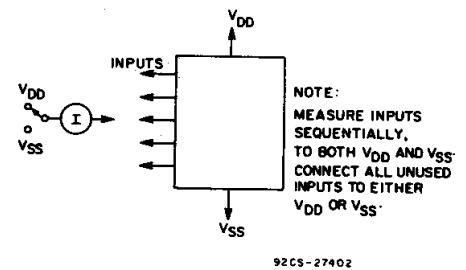


Fig. 10 — Input current test circuit.

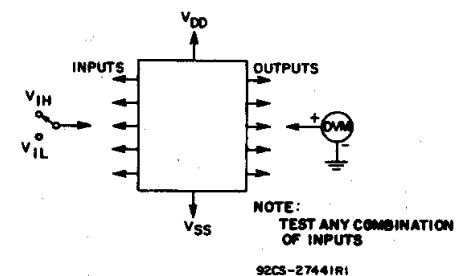


Fig. 11 — Input-voltage test circuit.

## CD4585B Types

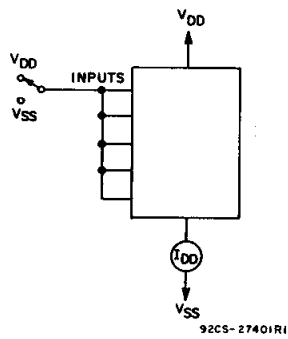
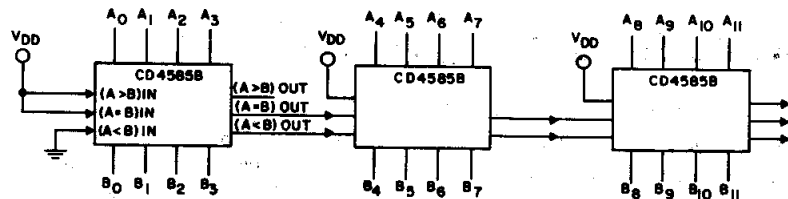


Fig. 12 - Quiescent-device-current test circuit.



$$t_{p \text{ TOTAL}} = t_{p \text{ (COMPARE) INPUTS}} + 2 \times t_{p \text{ (CASCADE) INPUTS}}, \text{ AT } V_{DD} = 10V$$

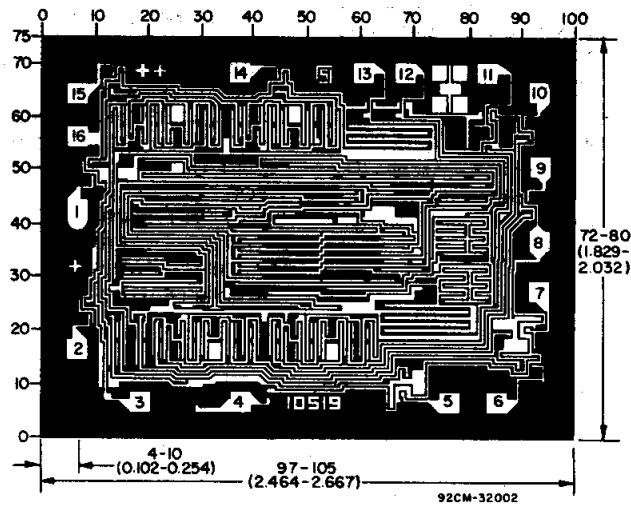
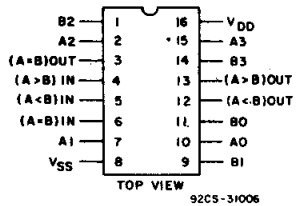
$$(3 \text{ STAGES})$$

$$= 120 + 2(80) = 280 \text{ ns (TYP.)}$$

92CM-31007R1

Fig. 13 - Typical speed characteristics of a 12-bit comparator.

### TERMINAL ASSIGNMENT



Dimensions and Pad Layout for CD4585BH

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|--------------------|------|-------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| 7703702EA        | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | Call TI          | Call TI              | -55 to 125   | 7703702EA<br>CD4585BF3A  | <a href="#">Samples</a> |
| CD4585BE         | ACTIVE        | PDIP         | N                  | 16   | 25          | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type   | -55 to 125   | CD4585BE                 | <a href="#">Samples</a> |
| CD4585BEE4       | ACTIVE        | PDIP         | N                  | 16   | 25          | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type   | -55 to 125   | CD4585BE                 | <a href="#">Samples</a> |
| CD4585BF3A       | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | 7703702EA<br>CD4585BF3A  | <a href="#">Samples</a> |
| CD4585BNSR       | ACTIVE        | SO           | NS                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4585B                  | <a href="#">Samples</a> |
| CD4585BNSRE4     | ACTIVE        | SO           | NS                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4585B                  | <a href="#">Samples</a> |
| CD4585BNSRG4     | ACTIVE        | SO           | NS                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4585B                  | <a href="#">Samples</a> |
| CD4585BPW        | ACTIVE        | TSSOP        | PW                 | 16   | 90          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM585B                   | <a href="#">Samples</a> |
| CD4585BPWE4      | ACTIVE        | TSSOP        | PW                 | 16   | 90          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM585B                   | <a href="#">Samples</a> |
| CD4585BPWG4      | ACTIVE        | TSSOP        | PW                 | 16   | 90          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM585B                   | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> Only one of markings shown within the brackets will appear on the physical device.

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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD4585BNSR | SO           | NS              | 16   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD4585BNSR | SO           | NS              | 16   | 2000 | 367.0       | 367.0      | 38.0        |



J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **<br>DIM      | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  -  The 20 pin end lead shoulder width is a vendor option, either half or full width.

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4211284-3/F 12/12

- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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